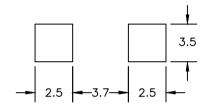
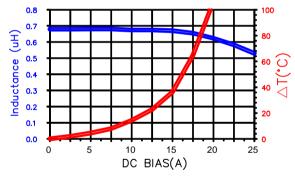
## MGV0603R68M-10

## PHYSICAL DIMENSIONS:

Α	7.30	±	0.50
В	6.70	±	0.30
С	3.00	±	0.30
D	2.90	±	0.30
Ε	1.60	$\pm$	0.50

## LAND PATTERNS FOR REFLOW SOLDERING

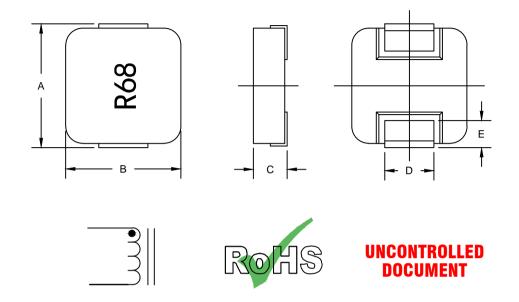




ELECTRICAL SPECIFICATION @ 25°C

	Min	Norm	Max	
INDUCTANCE (uH) L @ 100 KHz/0.25V	0.544	0.680	0.816	
DCR $(\Omega)$			0.0055	

Saturation Current <sup>3</sup> Isat (A)	25
Temperature Rise Current Irms <sup>4</sup> (A)	15.50



NOTES: UNLESS OTHERWISE SPECIFIED

- 1.COMPONENTS SHOULD BE ADEQUATELY PREHEATED BEFORE SOLDERING.
- 2.OPERATION TEMPERATURE RANGE: -40°C~+125°C (INCLUDING SELF-HEATING).
- 3.DEFINITION OF SATURATION CURRENT (ISAT): DC CURRENT AT WHICH THE INDUCTANCE DROPS  $\leq 25\%$  FROM ITS VALUE WITHOUT CURRENT (Ta=25 $\pm$ 5°C).
- 4.DEFINITION OF TEMPERATURE RISE CURRENT (IRMS): DC CURRENT THAT CAUSES THE TEMPERATURE RISE ( $\Delta T \leq 40^{\circ}$ C) FROM 25°C AMBIENT.

	DIMENSIONS ARE IN mm.			This print is the property of Laird					
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L					copies shall be made without the written consent of Laird Tech. All				
					rights to design or invention are				
Γ					reserved.				
Γ	D	UPDATE LOGO	04/22/15	QIU	PROJECT/PART NUMBER:	REV	PART TO	PE: WER	DRAWN BY:
	С	CHANGE NOTE 2.3.4	09/24/12	QIU	MGV0603R68M-10	D		OTOR QIU	
	æ	REVISE DIMENSIONS	06/27/12	Q	DATE: 06/27/12	CALE:	TS	SHEET:	
Γ	Α	ORIGINAL DRAFT	06/27/12	QIU		DOL #	13		
	REV	DESCRIPTION	DATE	INT	MGV0603R68M-10-D	,	-	1	of 1